

Rectifier Diode

Types W2058LC020 to W2058LC140

Old Type No.: SW12CXC935

Absolute Maximum Ratings

	VOLTAGE RATINGS	MAXIMUM LIMITS	UNITS
V_{RRM}	Repetitive peak reverse voltage, (note 1)	200-1400	V
V_{RSM}	Non-repetitive peak reverse voltage, (note 1)	300-1500	V

	OTHER RATINGS	MAXIMUM LIMITS	UNITS
$I_{F(AV)M}$	Maximum average forward current, $T_{sink}=55^{\circ}C$, (note 2)	2058	A
$I_{F(AV)M}$	Maximum average forward current, $T_{sink}=100^{\circ}C$, (note 2)	1508	A
$I_{F(AV)M}$	Maximum average forward current, $T_{sink}=100^{\circ}C$, (note 3)	924	A
$I_{F(RMS)M}$	Nominal RMS forward current, $T_{sink}=25^{\circ}C$, (note 2)	3726	A
$I_{F(d.c.)}$	D.C. forward current, $T_{sink}=25^{\circ}C$, (note 4)	3225	A
I_{FSM}	Peak non-repetitive surge $t_p=10ms$, $V_{rm}=60\%V_{RRM}$, (note 5)	19.5	kA
I_{FSM2}	Peak non-repetitive surge $t_p=10ms$, $V_{rm}\leq 10V$, (note 5)	21.5	kA
I^2t	I^2t capacity for fusing $t_p=10ms$, $V_{rm}=60\%V_{RRM}$, (note 5)	1.9×10^6	A^2s
I^2t	I^2t capacity for fusing $t_p=10ms$, $V_{rm}\leq 10V$, (note 5)	2.3×10^6	A^2s
$T_{j\ op}$	Operating temperature range	-40 to +175	$^{\circ}C$
T_{stg}	Storage temperature range	-40 to +200	$^{\circ}C$

Notes:-

- 1) De-rating factor of 0.13% per $^{\circ}C$ is applicable for T_j below $25^{\circ}C$.
- 2) Double side cooled, single phase; 50Hz, 180° half-sinewave.
- 3) Single side cooled, single phase; 50Hz, 180° half-sinewave.
- 4) Double side cooled.
- 5) Half-sinewave, $175^{\circ}C$ T_j initial.

Characteristics

	PARAMETER	MIN.	TYP.	MAX.	TEST CONDITIONS (Note 1)	UNITS
V _{FM}	Maximum peak forward voltage	-	-	1.63	I _{TM} =4400A	V
V _{FM}	Maximum peak forward voltage	-	-	1.8	I _{TM} =6175A	V
V _{T0}	Threshold voltage	-	-	0.79		V
r _T	Slope resistance	-	-	0.192		mΩ
I _{RRM}	Peak reverse current	-	-	30	Rated V _{RRM}	mA
I _{RRM}	Peak reverse current	-	-	30	Rated V _{RRM} , T _J =25°C	mA
Q _{rr}	Recovered charge	-	850	-	I _{TM} =1000A, t _p =1000μs, di/dt=10A/μs, V _r =50V	μC
Q _{ra}	Recovered charge, 50% Chord	-	600	850		μC
I _{rr}	Reverse recovery current	-	100	-		A
t _{rr}	Reverse recovery time	-	12	-		μs
R _{thJK}	Thermal resistance, junction to heatsink	-	-	0.033	Double side cooled	K/W
		-	-	0.066	Single side cooled	K/W
F	Mounting force	10	-	20		kN
W _t	Weight	-	340	-		g

Notes:-

1) Unless otherwise indicated T_J=175°C.

Notes on Ratings and Characteristics**1.0 Voltage Grade Table**

Voltage Grade	V_{DRM} V_{DSM} V_{RRM} V	V_{RSM} V	V_D V_R DC V
02	200	300	140
04	400	500	260
06	600	700	420
08	800	900	560
10	1000	1100	700
12	1200	1300	810
14	1400	1500	930

2.0 Extension of Voltage Grades

This report is applicable to other voltage grades when supply has been agreed by Sales/Production.

3.0 De-rating Factor

A blocking voltage de-rating factor of 0.13%/°C is applicable to this device for T_j below 25°C.

4.0 Snubber Components

When selecting snubber components, care must be taken not to use excessively large values of snubber capacitor or excessively small values of snubber resistor. Such excessive component values may lead to device damage due to the large resultant values of snubber discharge current. If required, please consult the factory for assistance.

5.0 Computer Modelling Parameters**5.1 Device Dissipation Calculations**

$$I_{AV} = \frac{-V_{T0} + \sqrt{V_{T0}^2 + 4 \cdot ff^2 \cdot r_T \cdot W_{AV}}}{2 \cdot ff^2 \cdot r_T} \quad \text{and:} \quad W_{AV} = \frac{\Delta T}{R_{th}} \quad \Delta T = T_{jmax} - T_K$$

Where $V_{T0}=0.79V$, $r_T=0.192m\Omega$,

R_{th} = Supplementary thermal impedance, see table below and

ff = Form factor, see table below.

Supplementary Thermal Impedance				
Conduction Angle	6 Phase (60°)	3 Phase (120°)	½ Wave (180°)	d.c.
Square wave Double Side Cooled	0.0455	0.0393	0.0362	0.0319
Square wave Single Side Cooled	0.0753	0.0711	0.0687	0.0646
Sine wave Double Side Cooled	0.0397	0.0350	0.0313	
Sine wave Single Side Cooled	0.0699	0.0677	0.0653	

Form Factors				
Conduction Angle	6 Phase (60°)	3 Phase (120°)	½ Wave (180°)	d.c.
Square wave	2.449	1.732	1.414	1
Sine wave	2.778	1.879	1.57	

5.2 Calculating V_F using ABCD Coefficients

The on-state characteristic I_F vs. V_F , on page 6 is represented in two ways;

- (i) the well established V_{T0} and r_F tangent used for rating purposes and
- (ii) a set of constants A, B, C, D, forming the coefficients of the representative equation for V_F in terms of I_F given below:

$$V_F = A + B \cdot \ln(I_F) + C \cdot I_F + D \cdot \sqrt{I_F}$$

The constants, derived by curve fitting software, are given below for both hot and cold characteristics. The resulting values for V_F agree with the true device characteristic over a current range, which is limited to that plotted.

	25°C Coefficients	175°C Coefficients
A	1.09345181	0.890075253
B	0.03122052	0.02367562
C	4.872×10^{-5}	5.14774×10^{-5}
D	1.8884×10^{-3}	4.745804×10^{-3}

5.3 D.C. Thermal Impedance Calculation

$$r_t = \sum_{p=1}^{p=n} r_p \cdot \left(1 - e^{\frac{-t}{\tau_p}} \right)$$

Where $p = 1$ to n , n is the number of terms in the series and:

t = Duration of heating pulse in seconds.

r_t = Thermal resistance at time t .

r_p = Amplitude of p_{th} term.

τ_p = Time Constant of r_{th} term.

The coefficients for this device are shown in the tables below:

D.C. Single Side Cooled					
Term	1	2	3	4	5
r_p	0.04013	6.3388×10^{-3}	0.011408	6.0275×10^{-3}	7.2098×10^{-4}
τ_p	4.07311	2.15774	0.19931	9.0689×10^{-3}	4.66345×10^{-4}

D.C. Double Side Cooled				
Term	1	2	3	4
r_p	0.017719	4.2406×10^{-3}	6.9638×10^{-3}	3.04366×10^{-3}
τ_p	0.708578	0.1435833	0.036152	2.1308×10^{-3}

6.0 Reverse recovery ratings

(i) Q_{ra} is based on 50% I_{RM} chord as shown in Fig. 1

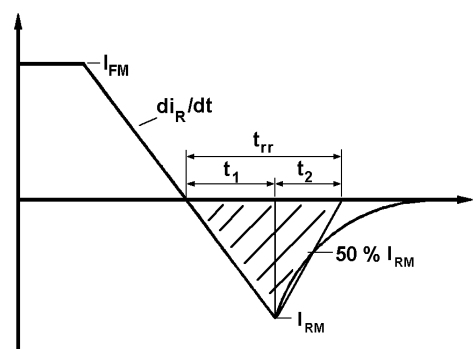


Fig. 1

(ii) Q_{rr} is based on a 150 μ s integration time i.e.

$$Q_{rr} = \int_0^{150\mu s} i_{rr} \cdot dt$$

(iii)

$$K \text{ Factor} = \frac{t_1}{t_2}$$

Curves

Figure 1 - Forward characteristics of Limit device

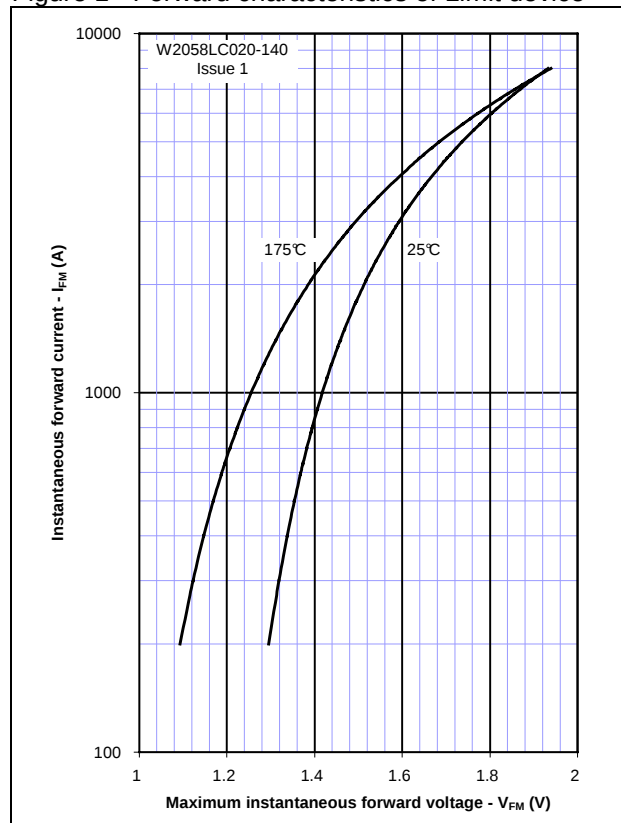


Figure 2 - Transient thermal impedance

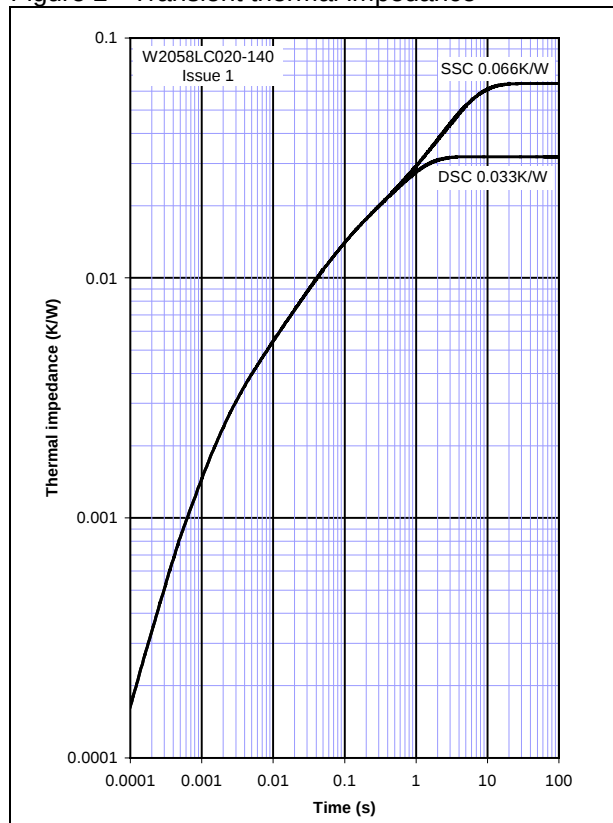


Figure 3 - Maximum surge Rating

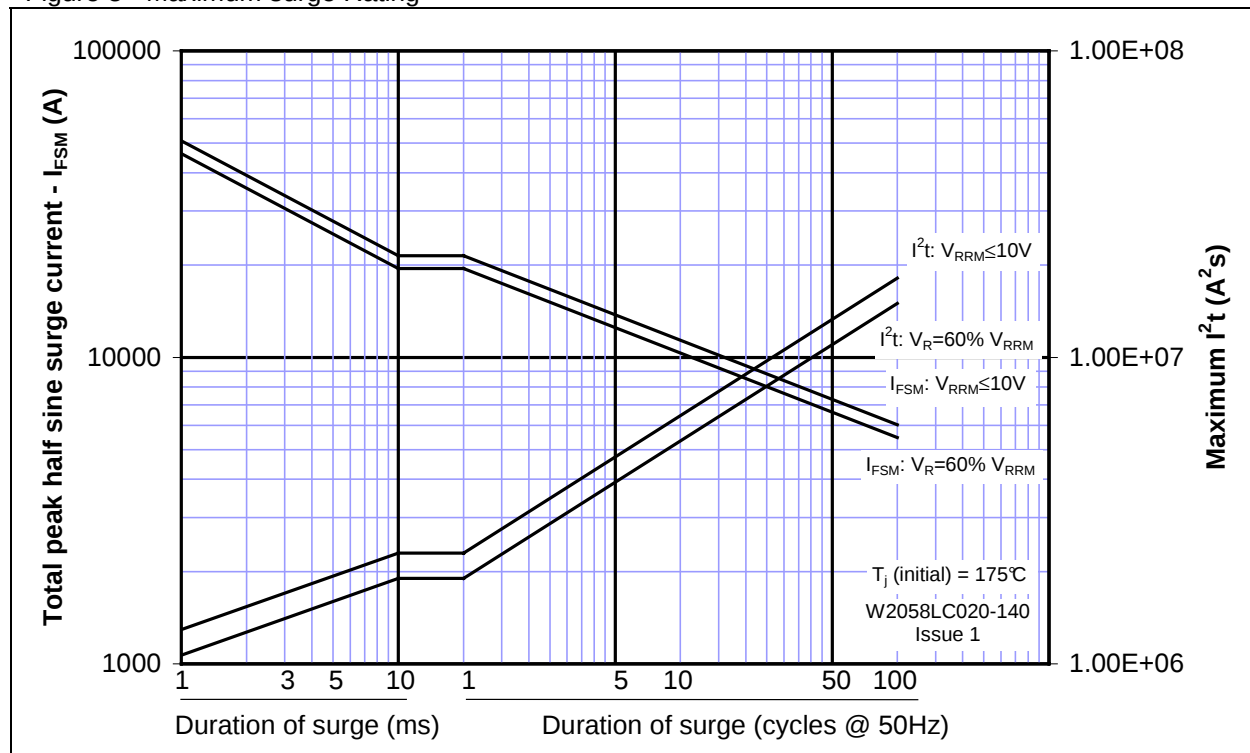


Figure 4 - Total recovered charge, Q_{rr}

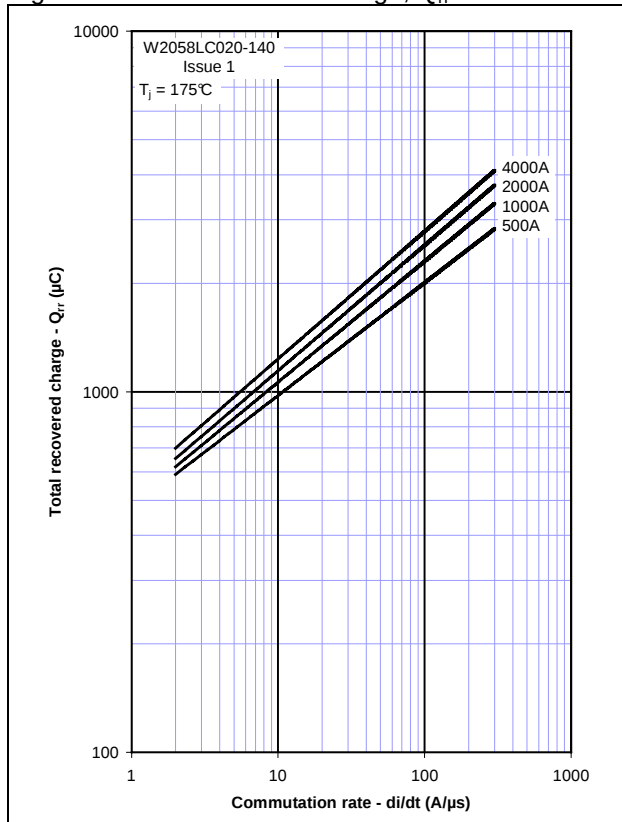


Figure 5 - Recovered charge, Q_{ra} (50% chord)

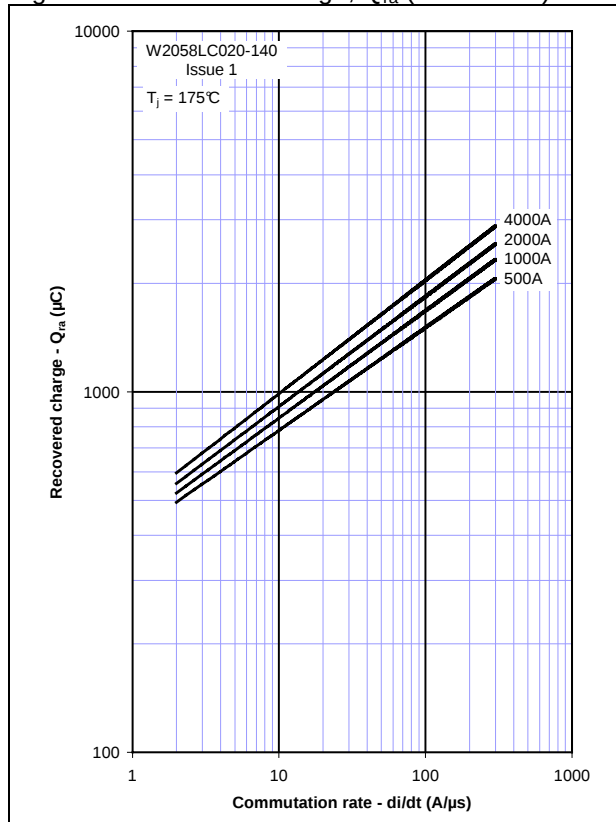


Figure 6 - Peak reverse recovery current, I_{rm}

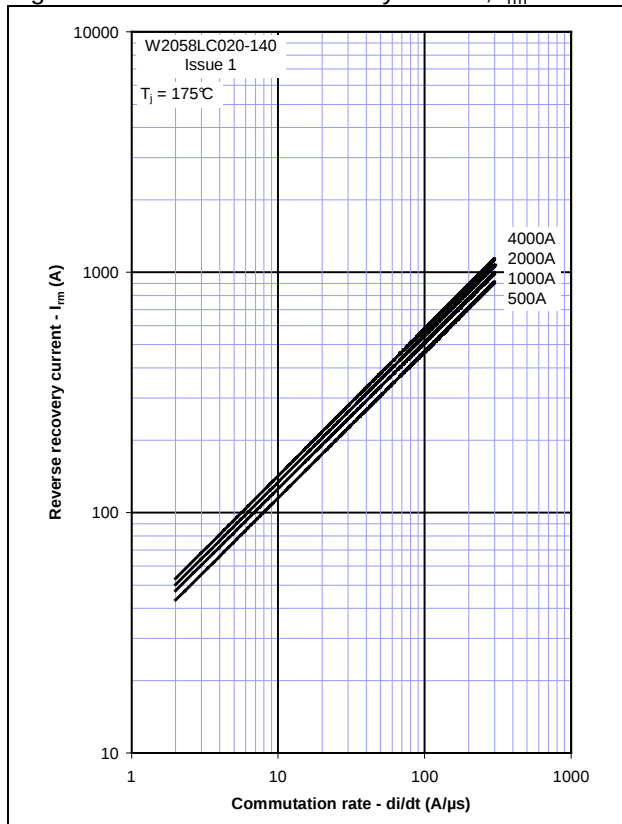


Figure 7 - Maximum recovery time, t_{rr} (50% chord)

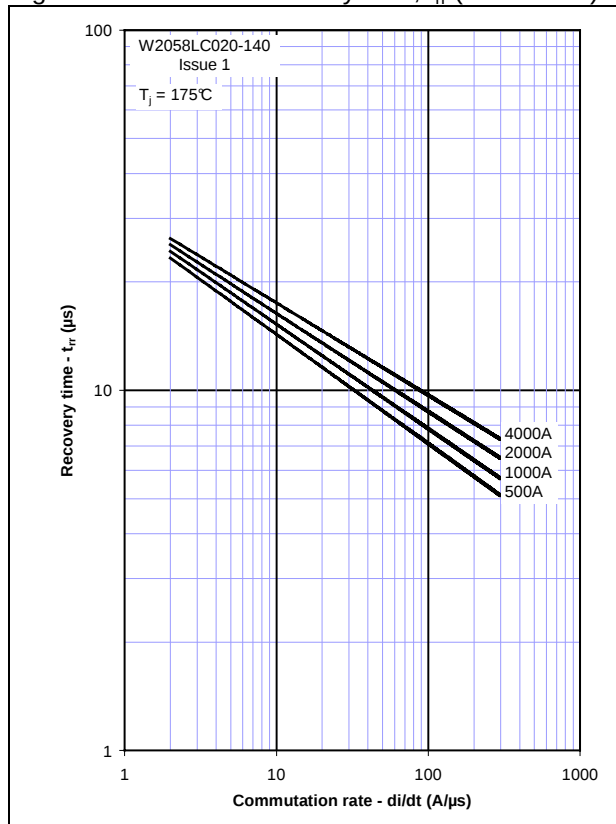


Figure 8 – Forward current vs. Power dissipation – Double Side Cooled

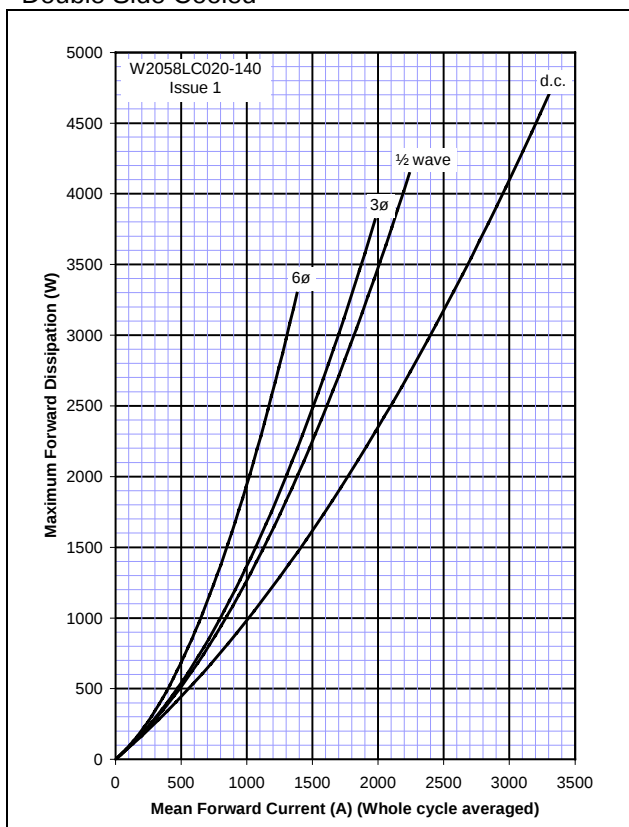


Figure 9 – Forward current vs. Heatsink temperature - Double Side Cooled

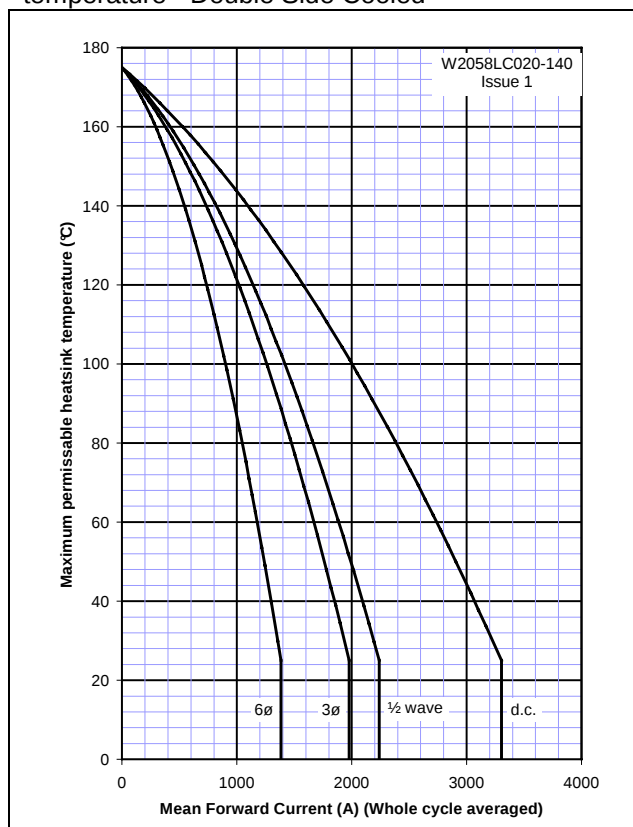


Figure 10 – Forward current vs. Power dissipation – Single Side Cooled

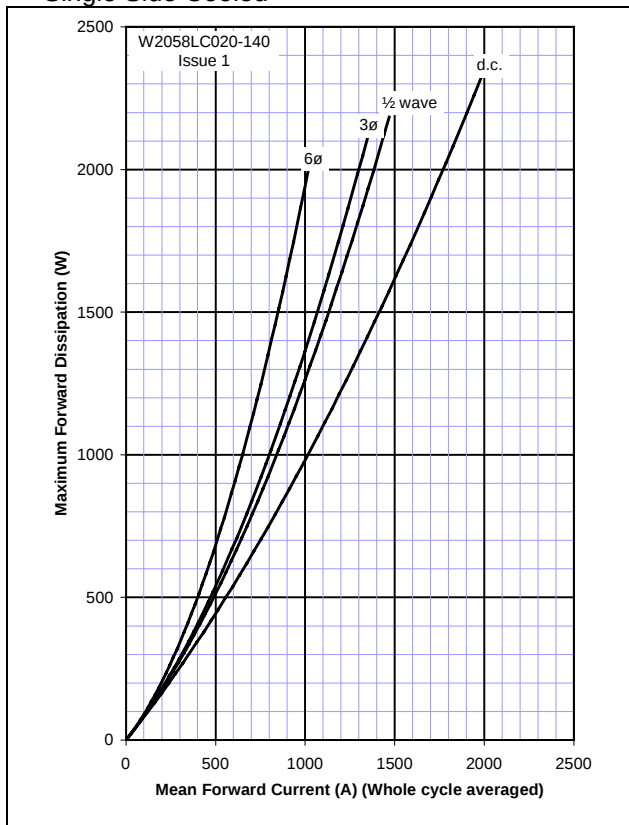
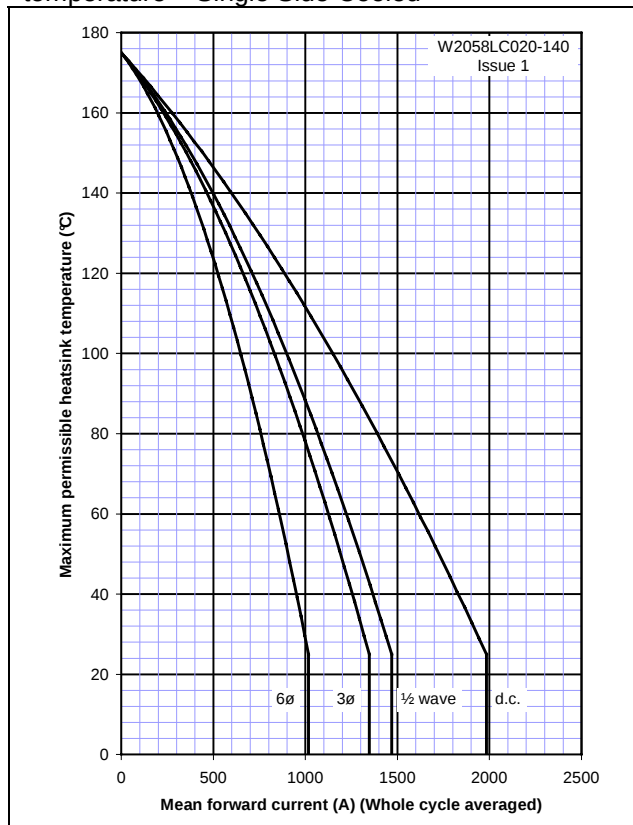
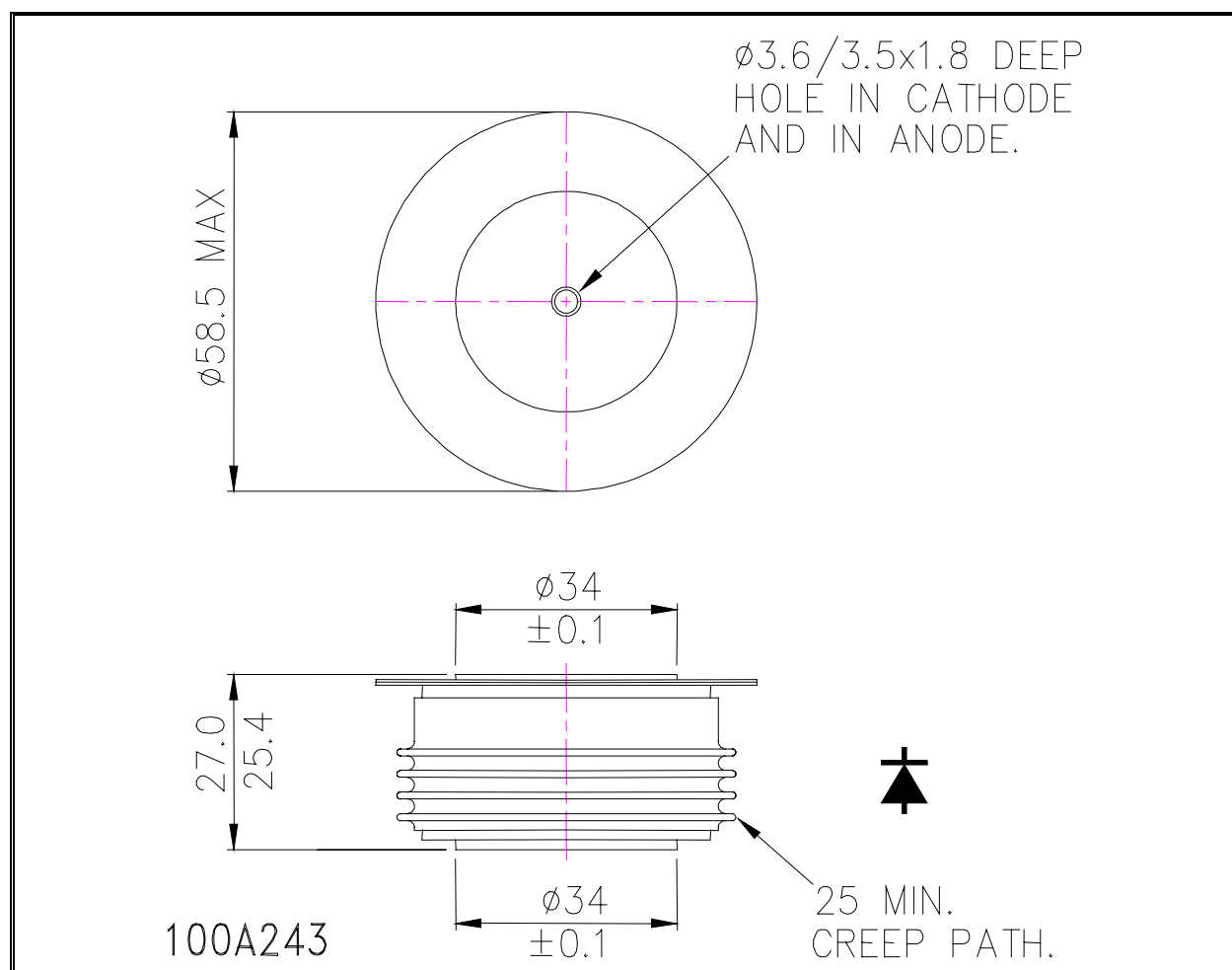


Figure 11 – Forward current vs. Heatsink temperature – Single Side Cooled



Outline Drawing & Ordering Information**ORDERING INFORMATION**

(Please quote 10 digit code as below)

W2058	LC	◆◆	0
Fixed Type Code	Fixed outline code	Voltage code $V_{DRM}/100$ 02-14	Fixed turn-off time code

Order code: W2058LC140 – 1400V V_{DRM} , V_{RRM} , 27mm clamp height capsule.**IXYS Semiconductor GmbH**

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